01-05-2005



RECORDATION

102904074

FOF COMMERCE

(Rev. 03/01) OMB No. 0651-0027 (exp. 5/31/2002)	PATENTS	ONLY	3 Trademark Office	
To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof				
Name of conveying party(ies): Daisuke Kuruma (10 /01/04)		Name and address of receiving Name: Sony Corporation Internal Address:	party(ies)	
Additional name(s) of conveying party(ies) attached?	Yes x No	Street Address: 6-7-35 Kitashinagawa Shinagawa-Ku		
	erger nange of Name veying parties	City: Tokyo Country: Japan Additional name(s) & address(es) attached:	Zip: 141-0001 Yes x No	
4. Application number(s) or patent nu If this document is being filed together with a A. Patent Application No.(s): 10/944, Addition	new application, the ex	B. Patent No.(s):		
Name and address of party to whom correspondence concerning document should be mailed:		Total number of applications and patents involved:	d 1	
Name: Ronald P. Kananen RADER, FISHMAN & GRAUER PLLC		7. Total fee (37 CFR 3.41) Enclosed	\$40.00	
Street Address: 1233 20th Street, N.W. Suite 501		Authorized to be charged Authorized to be charged (Form 2038 enclosed)	•	
City: State: Washington DC	Zip: 20036	8. Deposit account number: 18-0013 (Attach duplicate copy of this page if page)	ying by deposit account)	
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Statement and signature. To the best of my knowledge and belied is a true copy of the original document.		ormation is true and correct and any	attached copy	

Signature

Total number of pages including cover sheet/attachments, and documents:

01 FC:8021 40.00 DA

Ronald P. Kananen, Reg. No. 24,104

Name of Person Signing

PATENT REEL: 016114 FRAME: 0336

December 30, 2004

Date

Docket Number:	SON-3099

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in IMAGE PICKUP APPARATUS AND IMAGE PICKUP METHOD

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address:

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of this application in the spaces that follow: Serial Number:	record in this application to insert the serial number and filing date of Filing Date:		
This assignment executed on the dates indicated below.			
Daisuke KURUMA			
Name of first or sole inventor	Execution date of U.S. Patent Application		
Tokyo, Japan			
Residence of first or sole inventor			
Daisuke Kuruma	10/01/04		
Signature of first or sole inventor	Date of this assignment		

PATENT REEL: 016114 FRAME: 0337

RECORDED: 12/30/2004